REV.	ECN NO.	LOCATIONS	DESCRIPTION	DATE	DESIGN
A0			NEW RELEASE	12/24'21	Larry

ORDERING INFORMATION

TFPS - Z15 (XX T)

[1] [2] [3]

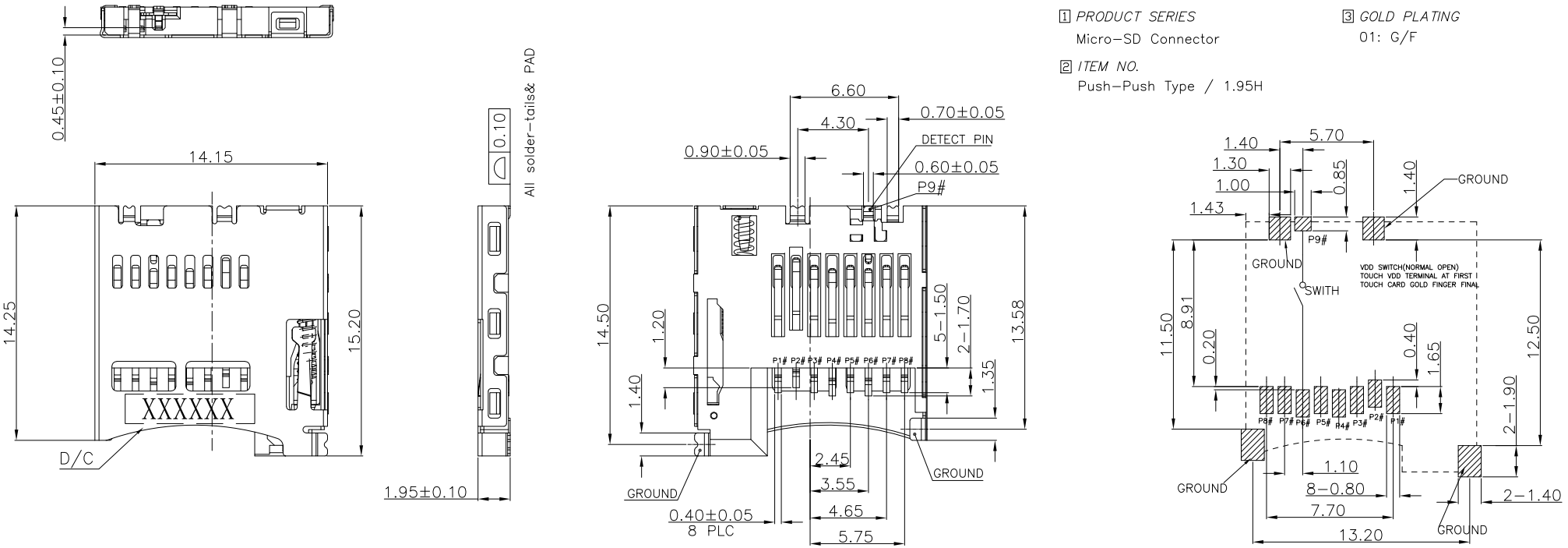
CUSTOMER DRAWING

RoHS Compliant

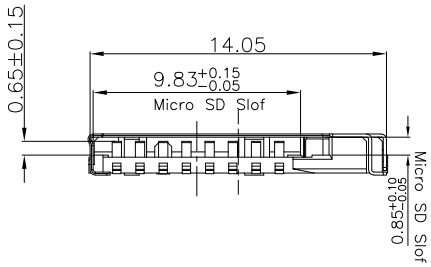
[1] *PRODUCT SERIES*
Micro-SD Connector

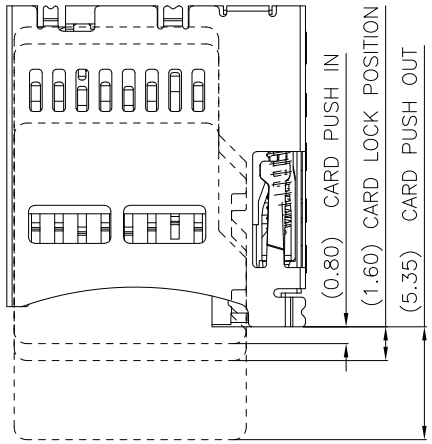
[2] *ITEM NO.*
Push-Push Type / 1.95H

[3] *GOLD PLATING*
01: G/F



RECOMMEND PCB LAYOUT
GENERAL TOLERANCE ±0.05

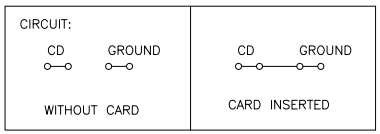




NOTES:
1.MATERIAL:
HOUSING: HIGH TEMP, UL94V-0 .
CONTACT: COPPER ALLOY.
SHELL: STAINLESS STEEL.
2.PLATING:
CONTACT: GOLD PLATED ON CONTACT AREA OVER NICKEL.
GOLD ON SOLDER TAIL OVER NICKEL.
SHELL: GOLD ON SOLDER TAIL OVER NICKEL.

PIN NO.	PIN ASSIGNMENT
1	DAT2
2	CD/DAT3
3	CMD
4	VDD
5	CLK
6	VSS
7	DAT0
8	DAT1
9	CARD DETECT

CIRCUIT:



DIM	TOL	DIM	TOL
X.X	±0.35	X.X°	±3.0°
X.XX	±0.25	X.XX°	±2.0°
X.XXX	±0.15	X.XXX°	±1.0°

SUNFUN SUNFUN TECHNOLOGY LTD

DRAW NO.	TFPS-Z15(A0)	DATE	MATERIAL: SEE NOTES	DRAW NAME: *Micro-SD PP CONNECTOR Push-Push Type / 1.95H*
DESIGN:	Larry	12/24'21	FINISH: SEE NOTES	
CHECK:	Larry	12/24'21	FILE: TFPS-Z15(A0)	MODEL: Micro-SD PP CONN
REVIEW:	Ziv	12/24'21	P/N: TFPS-Z15(XXT)	
APPROVED	Ziv	12/24'21	REV. A0 SCALE	UNIT: mm SHEET: 1/1